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Dated: April 8, 2009
Electronic Signature for James E. Armstrong, IV: /James E. Armstrong, IV/

Docket No.: 80154(302728)
(PATENT)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:
Takashi Yamaguchi et al.

Application No.: 10/539,884

Confirmation No.: 6471

Filed: June 16, 2005

Art Unit: 1791

For: COMPOSITE OF ALUMINUM MATERIAL
AND SYNTHETIC RESIN MOLDING AND
PROCESS FOR PRODUCING THE SAME

Examiner: D. N. Bodawala

AMENDMENT IN RESPONSE TO NON-FINAL OFFICE ACTION

MS Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir/Madam:

INTRODUCTORY COMMENTS

In response to the Office Action dated January 8, 2009, please amend the above-identified U.S. patent application as follows:

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks begin on page 9 of this paper.